## Automated and Near Real-time, Trace Contamination and Chemical Species Analysis for the Semiconductor Industry

#### H.M. 'Skip' Kingston March 27, 2003

#### Duquesne University,

Professor of Analytical Chemistry Departments of Chemistry and Biochemistry, Center for Environmental Research and Education Center for Microwave and Analytical Chemistry Pittsburgh, PA 15282

#### Metara Incorporated,

Chief Technical Officer 2567 East Arques Ave Sunnyvale, CA 94085



## **Overview**

- The "problems" as seen by a metrologist
- Metrology for contamination analysis in Semiconductor Fabrication
- New enabling technology needed
- Inventions required to impact the problem
- Analytical chemistry metrology tools
  - Standard methods and new methods
  - IDMS, IPMS, SIDMS
- Speciation and why it is important
  - "Chemically Significant Data"
    - Bob Helms, SEMATECH ULSI 3/25/02
    - Thomas Theis, IBM-ULSI 3/25/02

### Time relevant inclusive data – initial tests

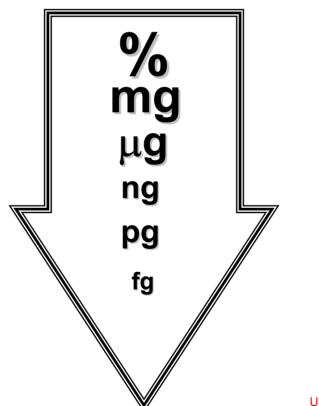
### **The Problem:**

At these dimensions Contamination is a critical parameter in the function and assembly of Semiconductors and Nanotechnology devices

- Nanotechnology As devices become 3 to 20 atoms in size, nanotechnology and micromachines predict contamination determines the viability of the device
- Semiconductor As semiconductor line widths go to <0.13 micrometers contamination become a critical limitation of the performance of these devices

The Relationship: As trend in ultra-trace element analysis go lower, previous techniques become inadequate and new methods are required to maintain or achieve accuracy & precision

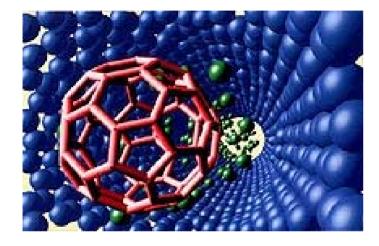
"New Thresholds Require New Methods"

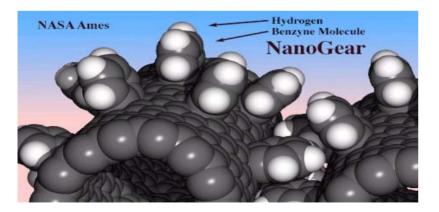


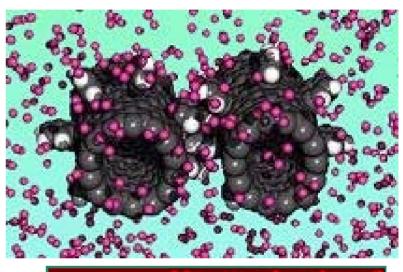


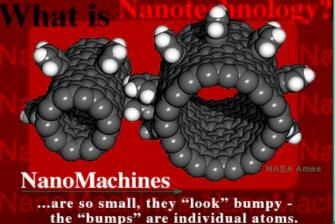
## Nanotechnology

## How much contamination does it take to act as a monkey wrench in the gears at the molecular level?









ULSI Conference 3/27/2003



### **ITRS Challenge #1**

### Semiconductor Road Map for Development Important Industry Directions!

"Key Area of the 2001 edition of the ITRS focus on the yield model and defect budget, defect detection and characterization, yield learning, and <u>wafer environment</u> <u>contamination control</u>."

Reference: "Examining upcoming yield enhancement challenges in the 2001 roadmap" Micro, February 2002



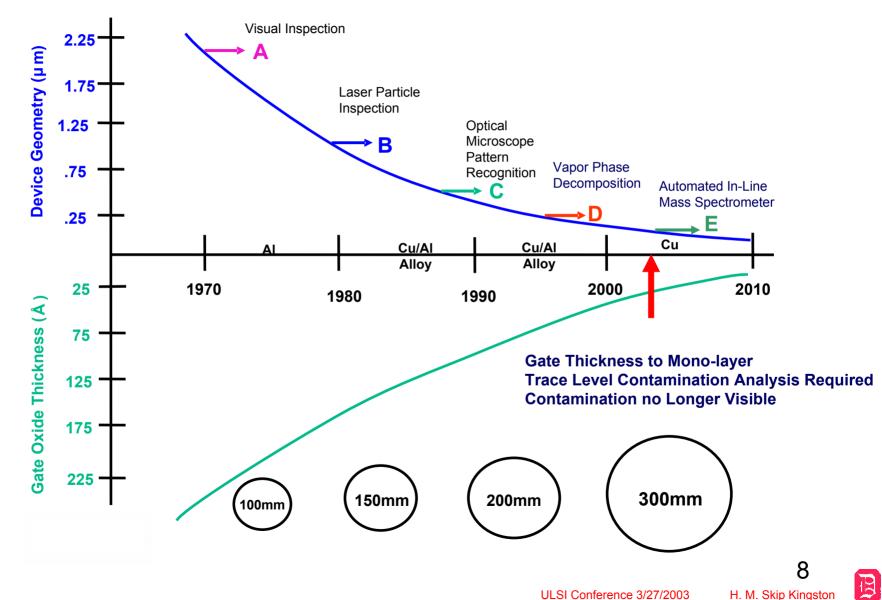
### ITRS Challenge #2 The Challenge?

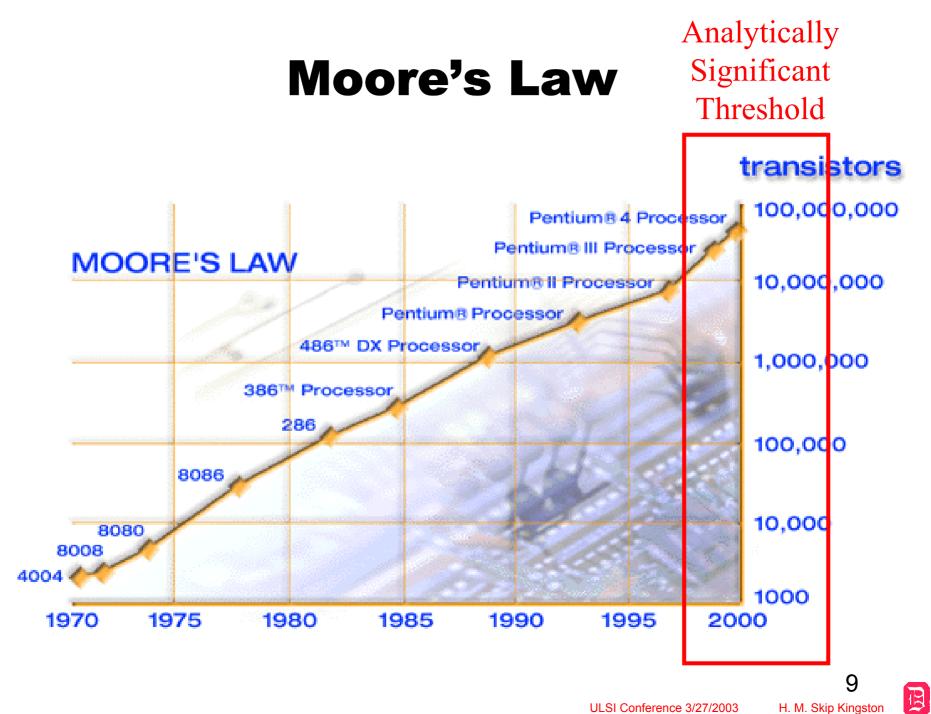
"The most critical challenge is to find ways to determine the effects of trace impurities on device performance and yield."

Reference: "Examining upcoming yield enhancement challenges in the 2001 roadmap" - *Micro*, February 2002

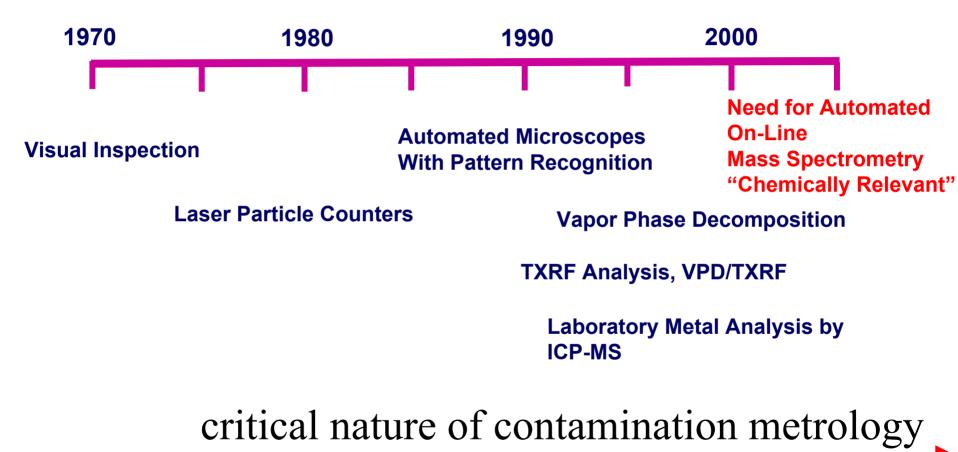
Authors:Christopher Long, IBM;<br/>Milton Godwin, Applied Materials;<br/>Manuela Huber, Sematech/Infineon;<br/>Richard Jarvis, Sematech/AMD<br/>Fred Lakhani, Sematech

#### **Moore's Law & Drives Contaminate Analysis Device dimensions increase importance and implementation of** contamination measurement metrology





### History of Contaminate Analysis for Semiconductors





### State-of-the-art: mid 2000 Project Begins

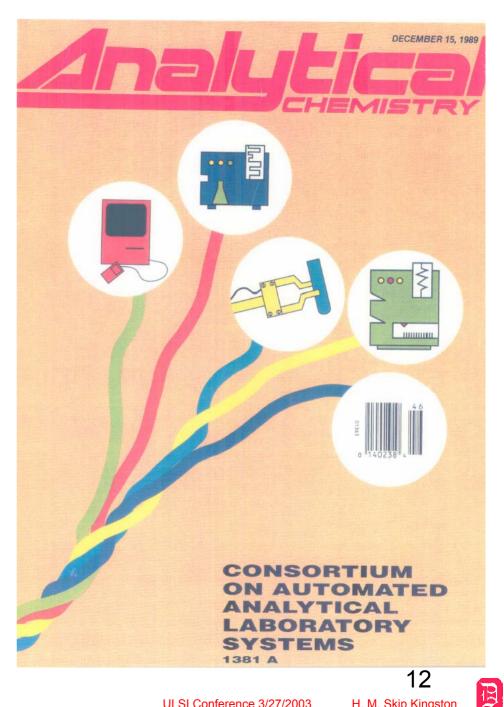
### Elemental metal analysis primarily

- Few anion, organic and no species information
- Species evaluation not considered feasible
- 6-12-24-48 hour sample to data turnaround is usual for metal analysis in semiconductor fabs
- Lack of on-line metrology for liquids
- Up to 60 liquid cleaning steps required in some advanced wafer processing
- Constituent analysis needs emerging eg. Cu ECD



U.S. Industries had before addressed a selected set of these critical metrology issues in an industry government consortium known as CAALS: NIST

- Hewlett-Packard
- Perkin-Elmer
- Dupont
- Union Carbide
- Kodak
- Department of Energy
- Zymark
- •et. al.



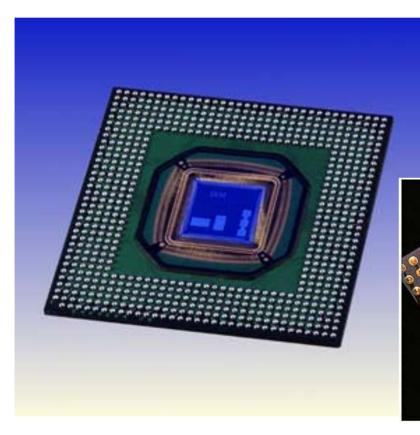
#### **State-of-the-art ICP-MS**

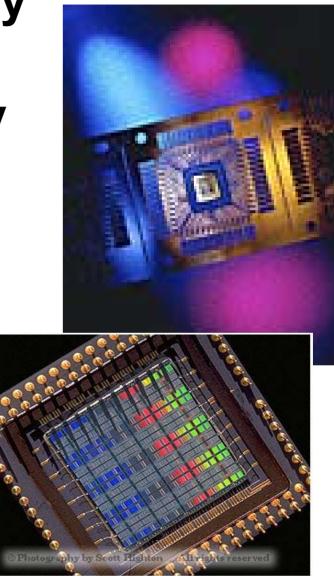
#### Desired Technology "Wish List"

ltem	ICP-MS	Desired Technology
Target Application	Lab applications	Real-time, In-line, In-fab: Trace contamination monitoring of standard aqueous semiconductor solutions
Sample Matrix	UPW, SC1, SC2, IPA, DHF, HN0 <sub>3</sub> , H <sub>2</sub> O <sub>2</sub>	UPW, SC1, SC2, IPA, DHF, HN0 <sub>3</sub> , H <sub>2</sub> O <sub>2</sub>
Monitors	Depends Upon Available Standards	20 - 28 Trace Contaminants
	Cations (+)	Cations (+) and anions (-)
	Elements	Elements and species
	Inorganics	Inorganics and Organics
Sample Preparation	Manual	Automated
Limit of Detection	< 20 ppt	< 20 ppt
Calibration and Quantitation Standards	Calibration Curves	Direct Analysis, Automated Calibration NIST tracible
Sample Volume	5 mL	<5 mL
Technology	ICP-MS	Based on Mass Spectrometer
Throughput	24 to 72 hours	5-10 sample/hr (5 min/sample)
Accuracy	± 25% at the quantitation limit	<± 25% at the quantitation limit 13
I		ULSI Conference 3/27/2003 H. M. Skip King

B

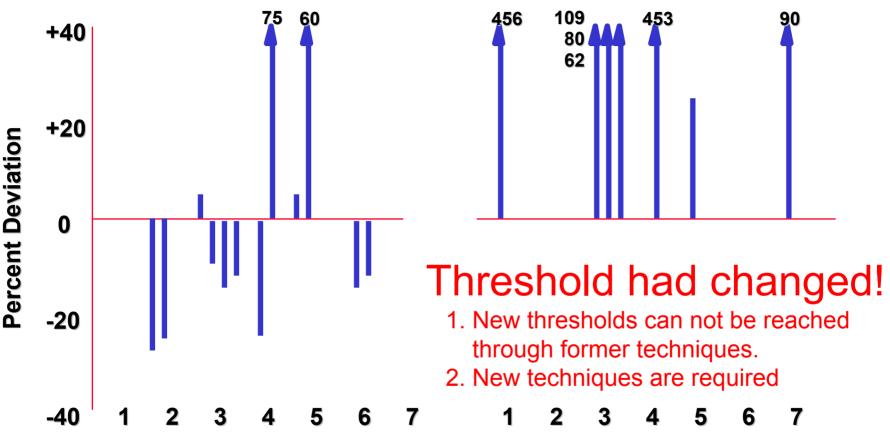
## Demanding Technology Requires Demanding Metrology





围

# **Example:** Comparison of Interlaboratory results of an Aqueous Standard and Whole Blood



#### Laboratories Aqueous Standard Laboratories Whole Blood

Reproduced from "The Role of the Analytical Blank in Accurate Trace Analysis" by T. J. Murphy, National Bureau of Standards Special Publication 422, Accuracy in Trace Analysis: Sampling, Sample Handling, and Analysis, Proceedings of the 7th IMR Symposium, Oct. 7-11, 1974, Pub. 1976.

ULSI Conference 3/27/2003

15

H. M. Skip Kingston

B

### **New Technology Required**

#### **An Unconventional Instrument:**

An Automated real-time integrated sample preparation and analysis system for inorganics, organics, and species, for the majority of cleaning and process solutions

What to do?

### Invent and Engineer a New Technology 16



图

H. M. Skip Kinaston

## **Recall – ITRS Challenge #2**

"The most critical challenge is to find ways to determine the <u>effects of trace</u> <u>impurities on device performance and</u> <u>yield</u>."

i.e. Statistically valid correlation and modeling i.e. "Chemically" significant determinations

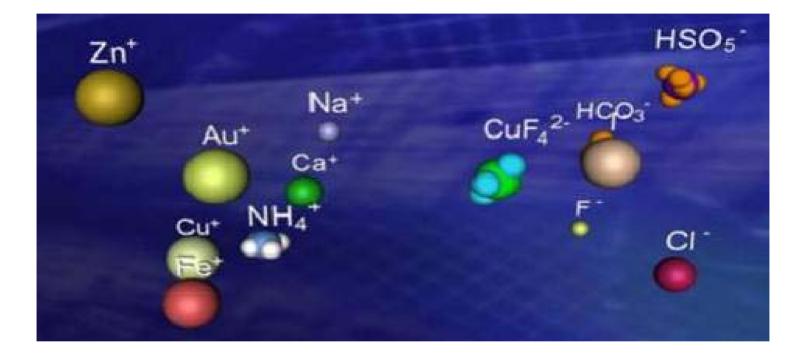
Reference:

"Examining upcoming yield enhancement challenges in the 2001 roadmap" - *Micro*, February 2002

Authors: Christopher Long, IBM; Milton Godwin, Applied Materials; Manuela Huber, Sematech/Infineon; Richard Jarvis, Sematech/AMD Fred Lakhani, Sematech



## Cations(+) & Anions(-)

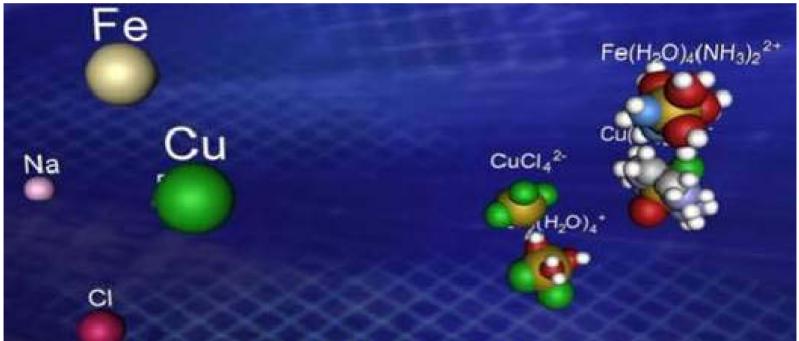


#### Cations





### **Elements & Species: Elemental Species Organic Molecules Inorganic Complex Species Organic Complex Species**



### Elements





19

ULSI Conference 3/27/2003

### Why Have Mass Spectrometers Not Been Used in On-Line, Real Time, Multi-matrix Rapid

### **Sequential Analysis?**

- Manual calibration requirement
- Lack of long term stability
- Matrix interferences
- Lack of instrument sensitivity in some matrices
- Inappropriate and unstable MS ionization sources
- Unavailability of fully automated systems
- Lack of applicable sample preparation integrated and automation with the mass spectrometer

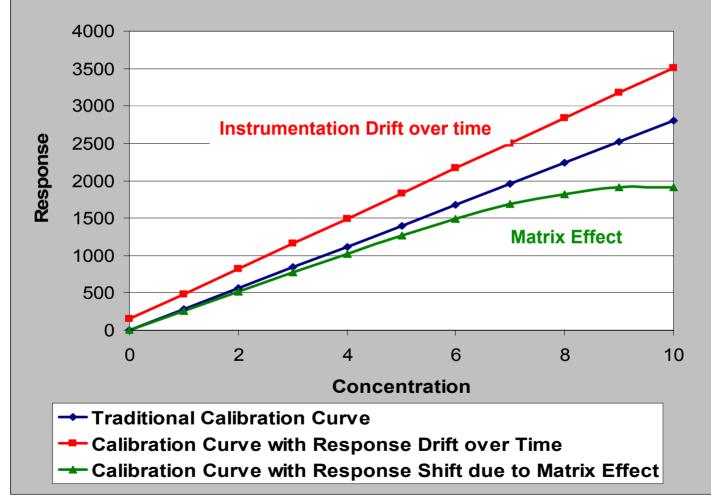


## **Mass Spectrometer Calibration**

- Mass Spectrometer Drift
- Requires Continual Calibration
- Method of Calibration Must be Reliable
- Method Desired to be Matrix Independent
- Calibration Solutions Should Inexpensive
- Method must be very fast



## Quantitation: Traditional Calibration Curve



Example, Examination of One Approach: On-Line, Real-Time, Automated, Direct Quantization for Elements, Species and Complex Molecular Species

 Direct Quantization through On-Line IDMS and SIDMS as a new capability:

In Process Mass Spectrometry or "IPMS"

- Fundamental enabling technology
- Alternative and simultaneous measurement of elements, molecules, and molecular species



### **Questions to consider:**

1. What new technology do you see that you do not expect?

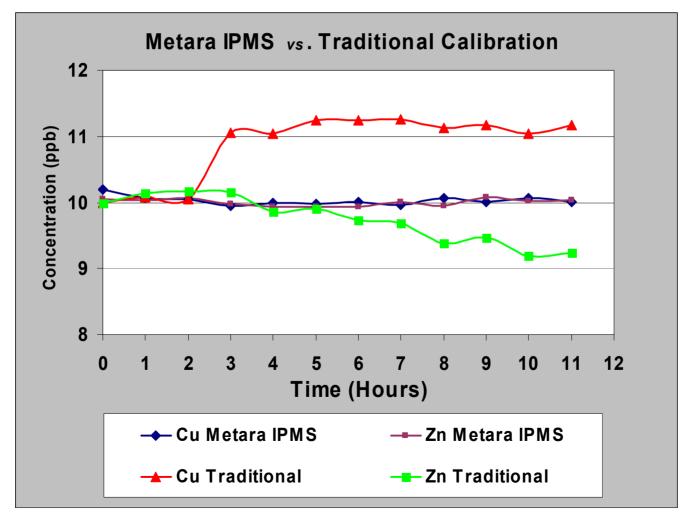
2. Does technology Changes the way we do things?3. Does it change what we call "normal"?

4. Do you think his son will use a drum?





#### Mass Spectrometer Drift Example: IPMS vs. Traditional -IPMS reduces or eliminates effects of mass spectrometer drift, enabling automation (patent pending)

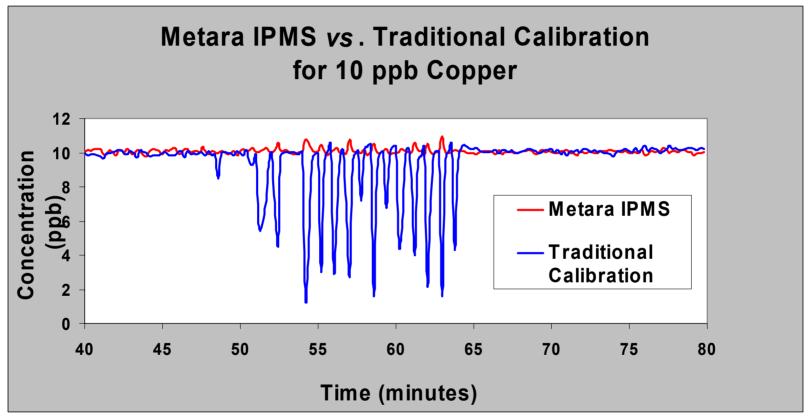


25 H. M. Skip Kingston

ULSI Conference 3/27/2003

R

#### Mass Spectrometer Signal Stability Example: IPMS compensating for MS stability, retaining accuracy, and enabling automation (patent pending)



With a typical analytical instrument, air bubbles in the sample introduction system may cause a dramatic instability and/or decrease in signal.

However, <sup>63</sup>Cu: <sup>65</sup>Cu isotope ratio measured by the IPMS Method remain constant.

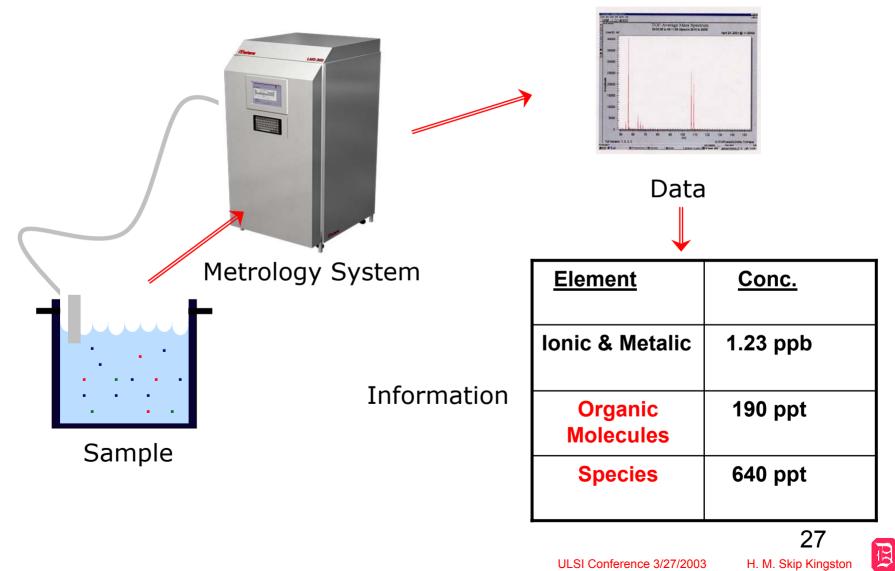


26

H. M. Skip Kingston

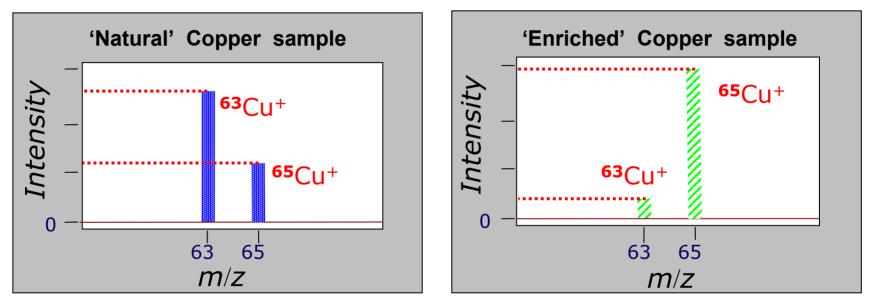
R

## **Technology Overview**



#### **Quantification Method** Metara In-Process Mass Spectrometry (IPMS)

#### e.g. Mass-Spectra of Copper Samples

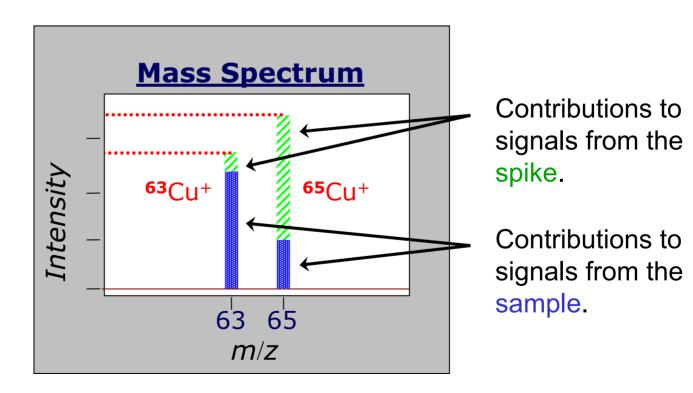


<sup>63</sup>Cu & <sup>65</sup>Cu occur naturally in a 69:31 abundance ratio. Isotopically-enriched solutions are commercially available (*e.g.* 5:95).

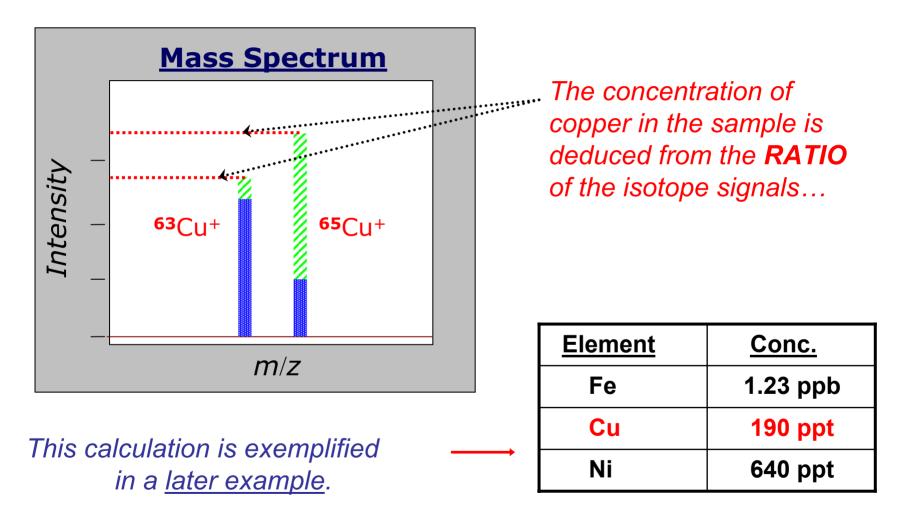
B

#### Quantification Method Metara IPMS

A sample of copper of unknown concentration is 'spiked' with a known amount of an isotopically-enriched standard, and introduced into the LMS-300 TCA.



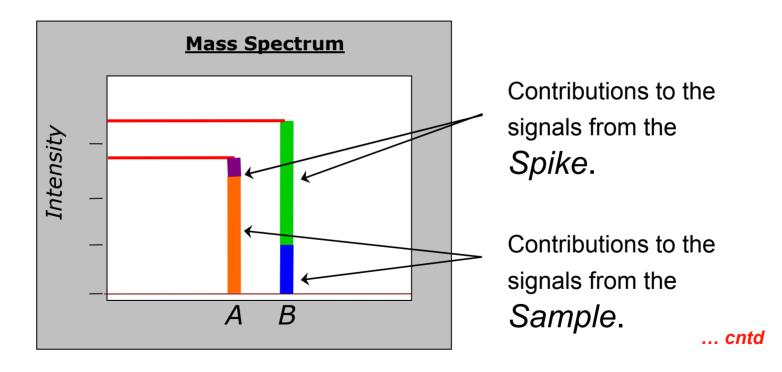
#### Quantification Method Metara IPMS



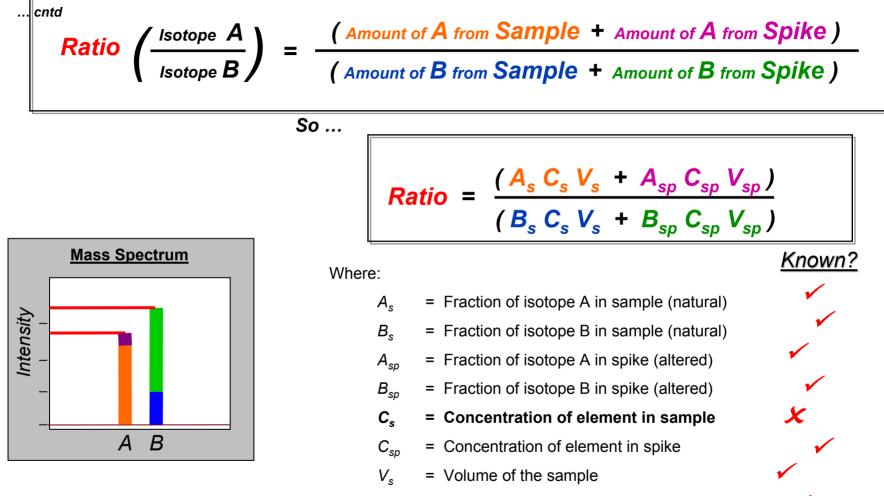
图

## **Metara IPMS Calculation**





# **Calculation & Formula**

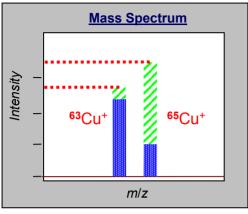


 $V_{sp}$  = Volume of the spike

**Solve for C\_s**, (the concentration of the element in the sample) ...

13

## **Quantitation of Cu**



Known & Measured Values

- The isotope ratio in the enriched spike standard, 1)  $= 0.05 : 0.95 (^{63}Cu : ^{65}Cu)$  $(A_{sp} \& B_{sp})$
- 2) The concentration of the spike standard solution,

= 0.88 ppb = 13.6 nmol/L $(C_{sp})$ 

- 3) The relative volumes of the spike and sample.  $(V_{sp} / V_s)$ 
  - = 0.13 (spike / sample)
- Measured Isotope Ratio 4)

 $= 0.82 (^{63}Cu / ^{65}Cu)$ (Ratio)

5) Natural Isotope Ratio = 0.692 : 0.308 (

$$(^{63}Cu : ^{65}Cu)$$
 (*A<sub>s</sub>* & *B<sub>s</sub>*)

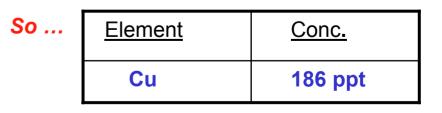
... cntd

Ratio = 
$$\frac{(A_s C_s V_s + A_{sp} C_{sp} V_{sp})}{(B_s C_s V_s + B_{sp} C_{sp} V_{sp})}$$

#### Rearrange the equation to solve for $C_s$

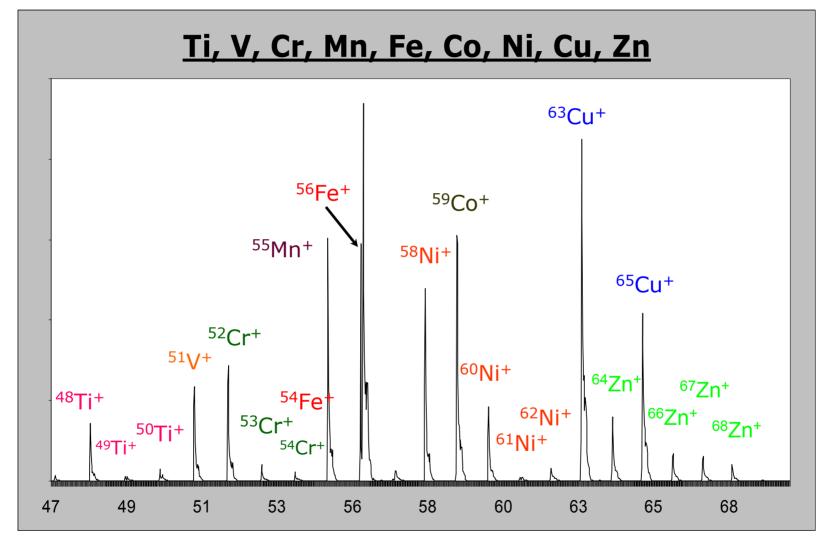
$$C_{s} = C_{sp} \left( \frac{V_{sp}}{V_{s}} \right) \left( \frac{A_{sp} - Ratio \times B_{sp}}{(Ratio \times B_{s} - A_{s})} \right)$$

$$C_{s} = 13.6 \text{ nmol/L} \times 0.13 \times \frac{(0.05 - 0.82 \times 0.95)}{(0.82 \times 0.308 - 0.692)}$$



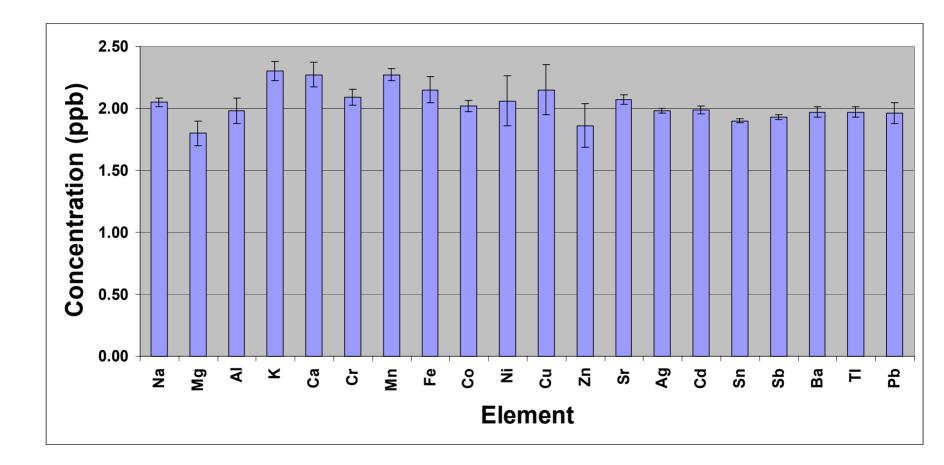
图

### First Row Transition Metals In Hard Ionization Mode

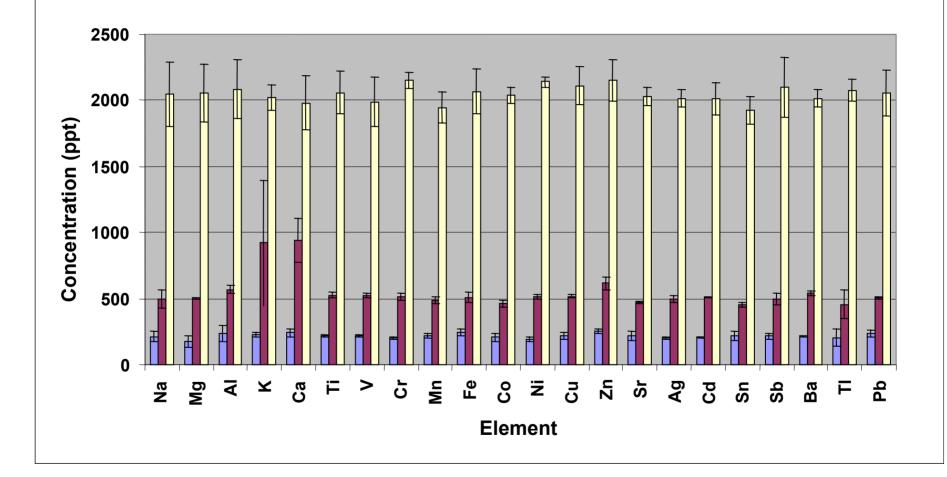


围

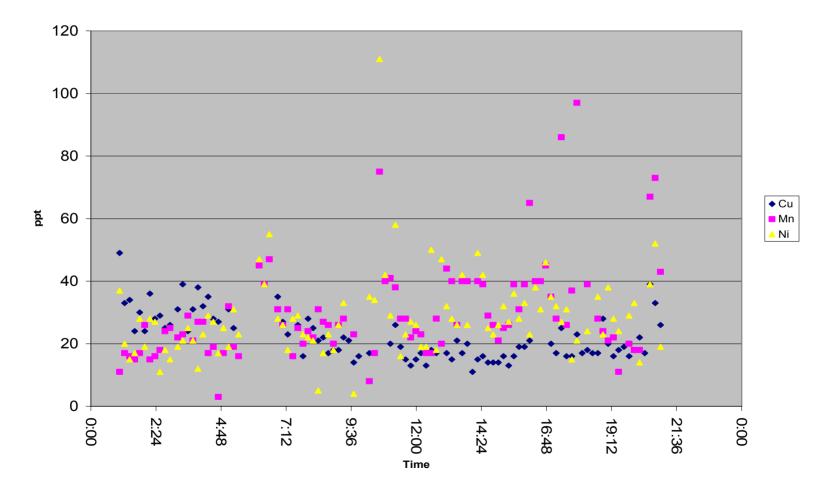
#### IP-MS Performance for SC1 at 2 ppb 90% Confidence Limits, n = 3



#### IPMS, TCA analysis of 200, 500, 2000 ppt Solutions UPW Matrix, n=3, 90% Confidence Limit

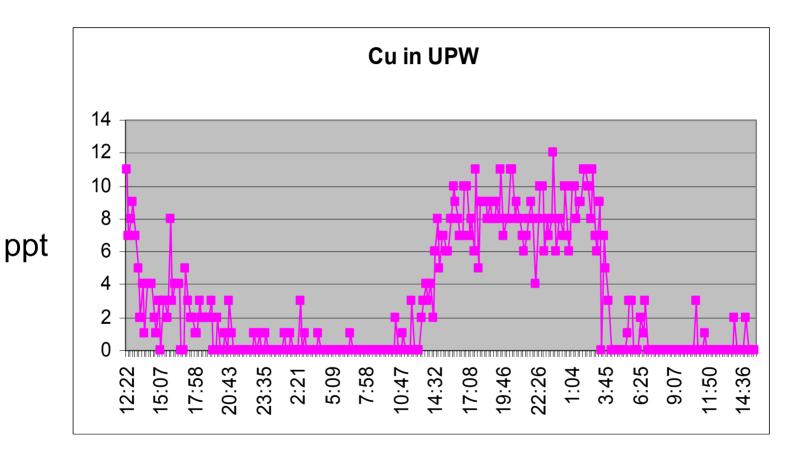


#### On-line Monitoring: Cu, Ni and Mn Concentrations vs. Time in a SC1 Cleaning Bath



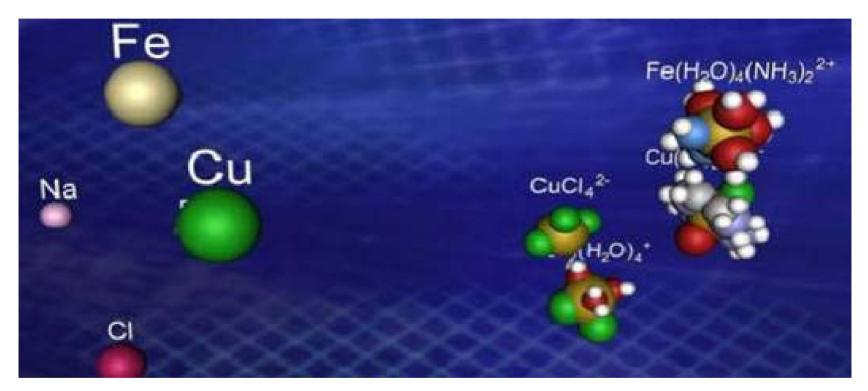
12

## **Trend Data for Cu in UPW**



time, h

#### **Elements & Species**



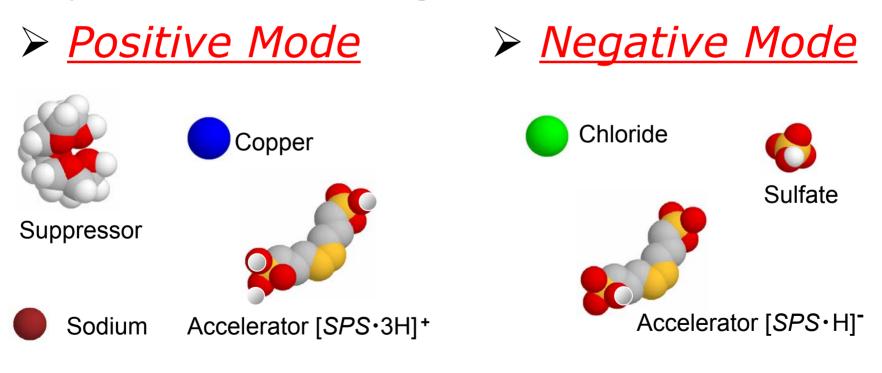
#### Elements





#### **Ionization: Cations, Anions, Species**

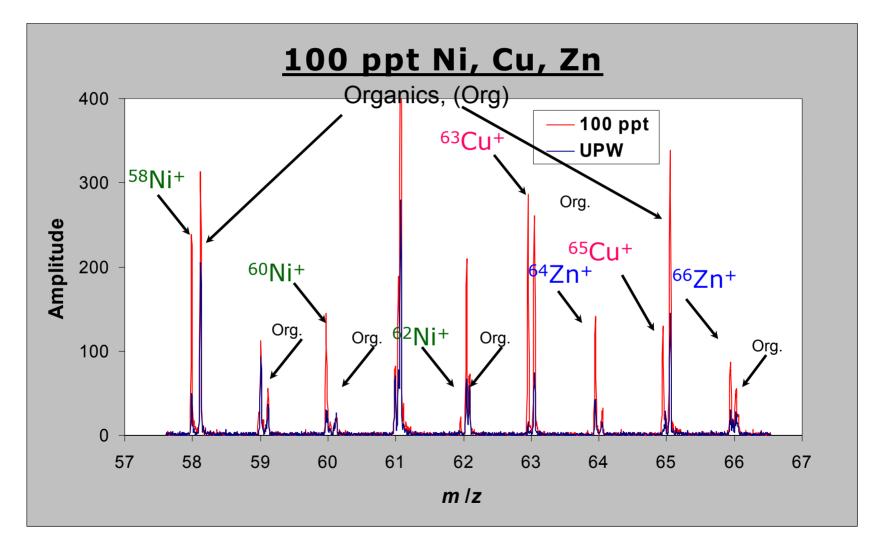
The instrument can detect *cations*, *anions*, *and molecular species* by reversing the polarity of appropriate voltages in the massspectrometer and using soft or hard ionization.



#### Chemical Species Measurement Reveal Fundamental Molecular Structure and Chemical Mechanisms

- Contamination control depends directly on molecular species and mechanisms causing the contamination or controlling the process
- Species reveal the chemical processes involved and contain information relating the
  - Origin
  - Effect
  - Prevention
  - Remediation
  - System

#### Ni, Cu, Zn In Soft Ionization Mode Include Organic Molecular Ions



E

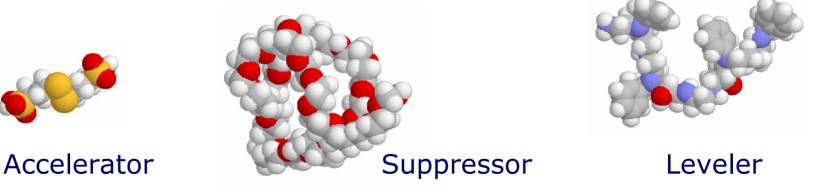
## Speciation Example: Cu Species Identification in Semiconductor Solutions

- Elemental quantitative mode: total Cu
- Speciation mode Process info
- Example
  - UPW bath:  $[Cu(H_2O)_4]^{2+}$
  - HF bath:  $[CuF(H_2O)_3]^+$
  - SC-1 bath: [Cu(NH<sub>3</sub>)<sub>2</sub>(H<sub>2</sub>O)<sub>4</sub>]<sup>2+</sup>
  - SC-2 bath: [Cu(OOH)Cl<sub>2</sub>]<sup>-</sup>
- Identifying Cu species in the monitored process, reveals sources, pathways and mechanisms of the Cu contamination.

#### Ionization: Elemental vs. Speciation

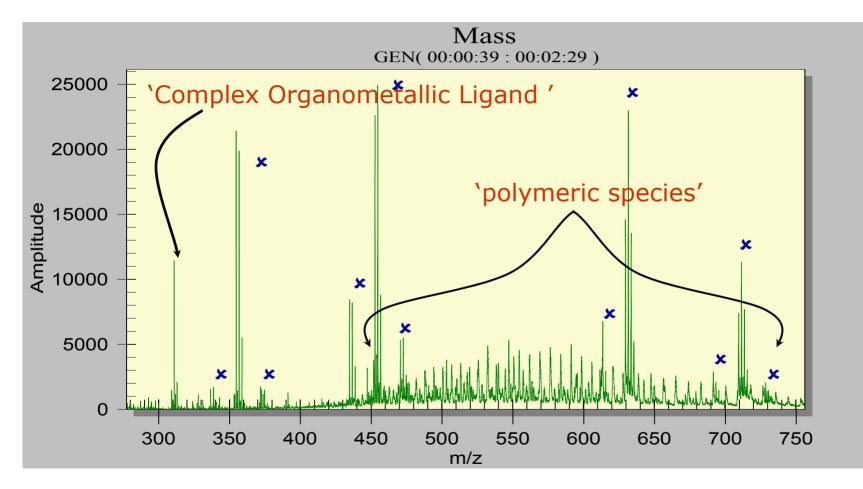
#### Speciation Mode of Analysis for Organics & Inorganic Complexes

- `Soft' mode the molecular ions are imparted with a low kinetic energy in the gas-phase.
- Gentle collisions minimize fragmentation and ligand loss.
- The integrity of the solution-species is preserved:



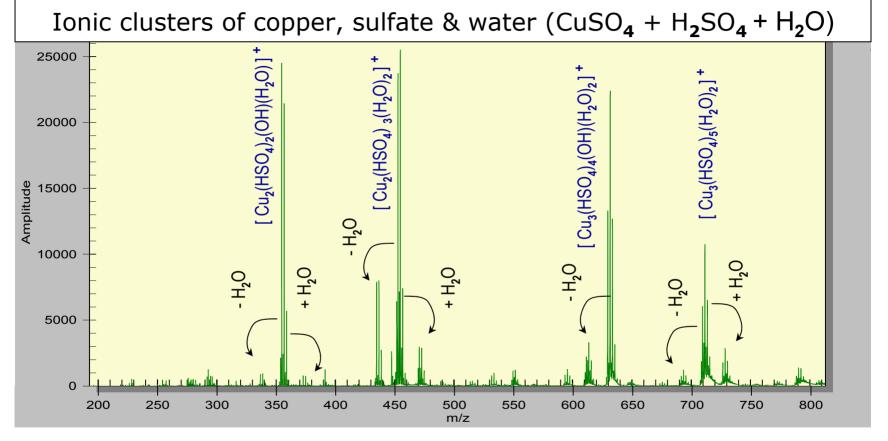
- Diagnostic tool for revealing the chemistry of the process
- Provides rich information for yield enhancement tools

#### Mass Spectrum of Complex Sample: Cu plating bath solution



**x** = Organometallic cluster ions

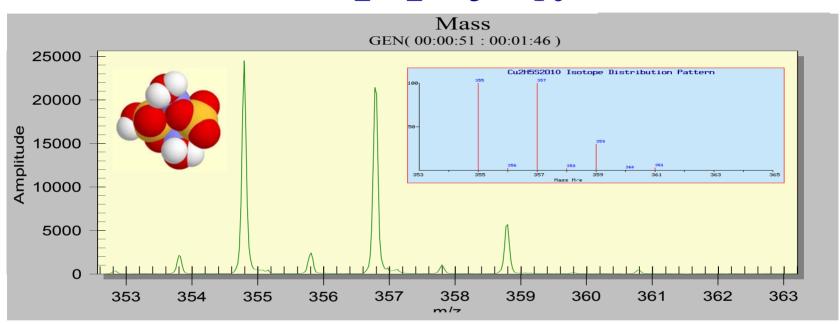
#### **Cu 'reagent': Speciation Mode Qualitative and Quantitative**



- 'Soft Ionization' in Speciation Mode encourages detection of intact clusters of copper ions with sulfate and water, by minimizing their fragmentation in the mass-spectrometer.
- These parameters have selected for copper sulfate clusters containing 2 & 3 copper ions (at below and above  $m/z \sim 500$  respectively) with a charge, z, of +1.
- The chemical formulae of the species are reliable, although the structural assignments are speculative.

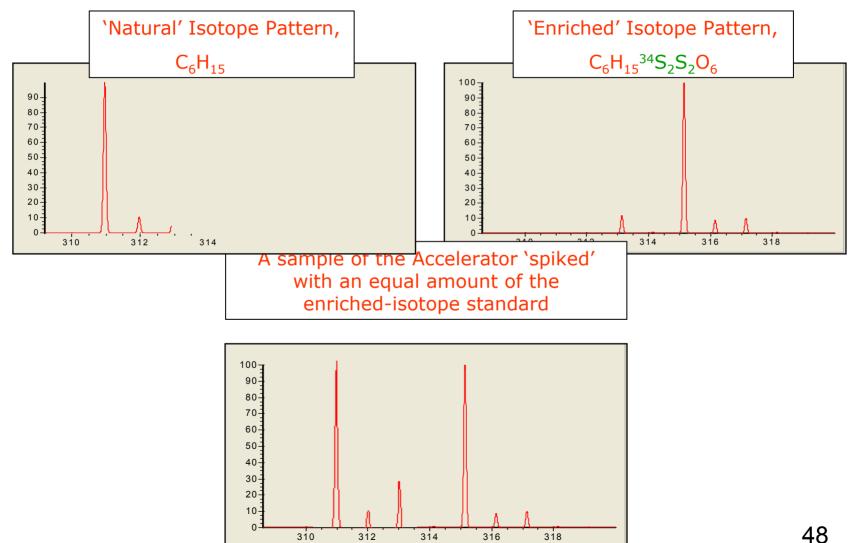
图

# Qualitative Identification and Quantitative Analysis of one Copper species: $[Cu_2S_2H_5O_{10}]^+$



- The **isotope peak pattern** is consistent with the chemical formulation; the most abundant isotopes of both copper and sulfur differ by 2 a.m.u. (<sup>63</sup>Cu & <sup>65</sup>Cu, and <sup>32</sup>S & <sup>34</sup>S).
- There is an excellent match between the **measured** & **calculated** masses for the major isotope peak (**354.7922** and **354.7916** a.m.u. respectively).
- The set of peaks of lower intensity offset by 1 a.m.u. is consistent with the formulation  $[Cu_2S_2H_4O_{10}]^+$ , perhaps formed by the collisional loss of a hydrogen atom in the mass-spectrometer.

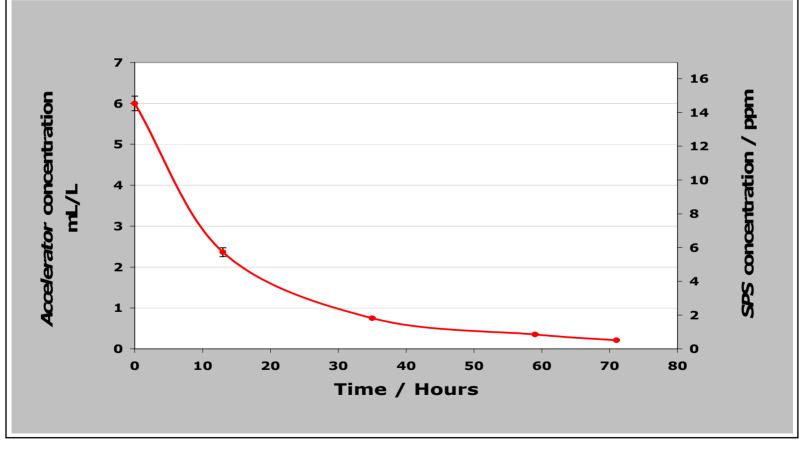
#### Quantitation of the Accelerator Bis(3-sulfopropyl) disulfide (SPS) by Isotopically-Enriched Spike



图

#### **Trend Data**

## Rate of *Accelerator* (*SPS*) Change in a Cu-ECD Test Facility

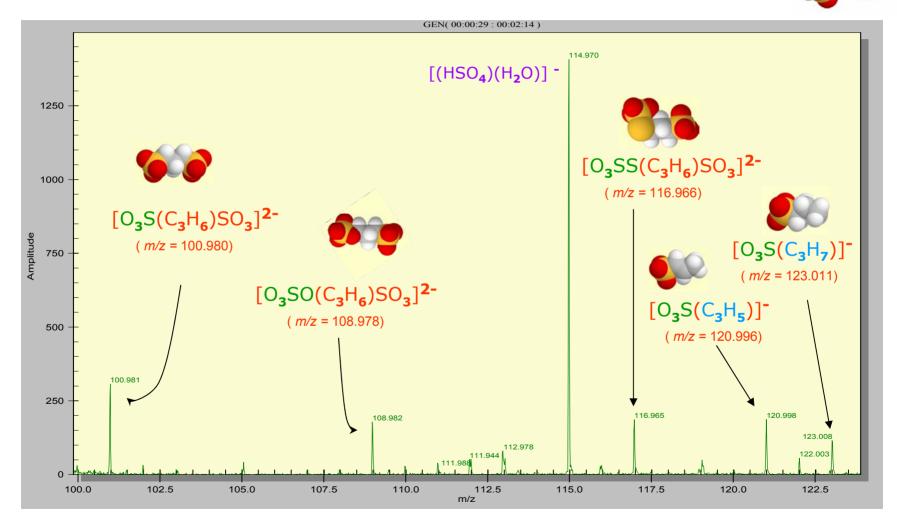


• 10 amps • 1.635 V • 2 Sabre anodes

ULSI Conference 3/27/2003

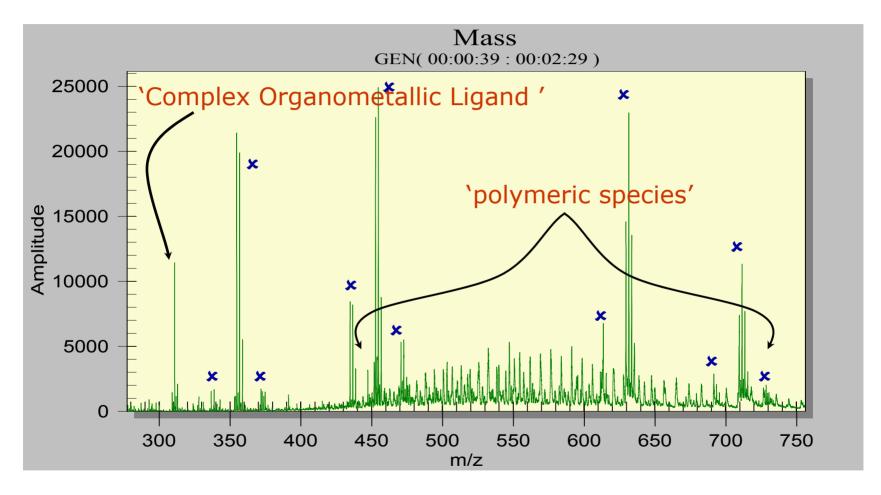
图

## Decomposition of the Accelerator SPS in an Aged Sample



H

#### **Mass Spectrum of Complex Sample**



Sector Sector

#### **ITRS Challenge #2**

## What is the Challenge?

#### "The <u>most critical</u> challenge is to find ways to determine the <u>effects of trace</u> <u>impurities on device performance and</u> <u>yield</u>."

Reference:	"Examining upcoming yield enhancement challenges in the 2001 roadmap"
	- <i>Micro</i> , February 2002
Authors:	Christopher Long, IBM;
	Milton Godwin, Applied Materials;
	Manuela Huber, Sematech/Infineon;
	Richard Jarvis, Sematech/AMD
	Fred Lakhani, Sematech

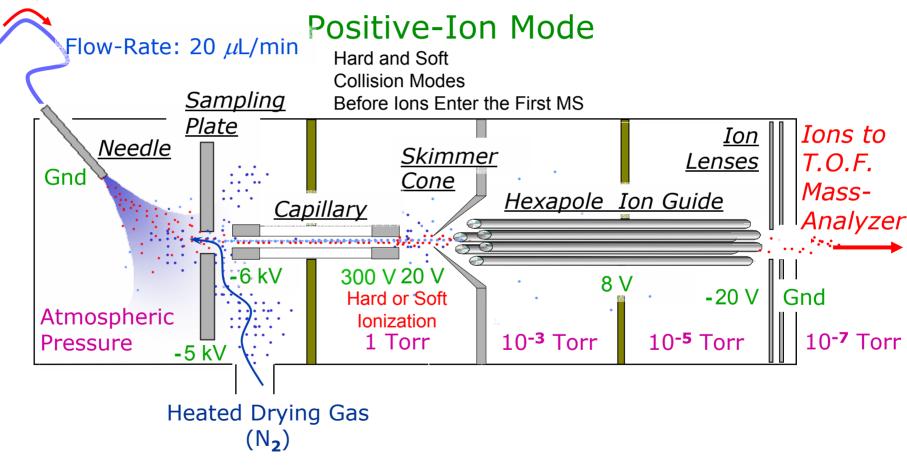
ULSI Conference 3/27/2003

#### **The Integrated System**

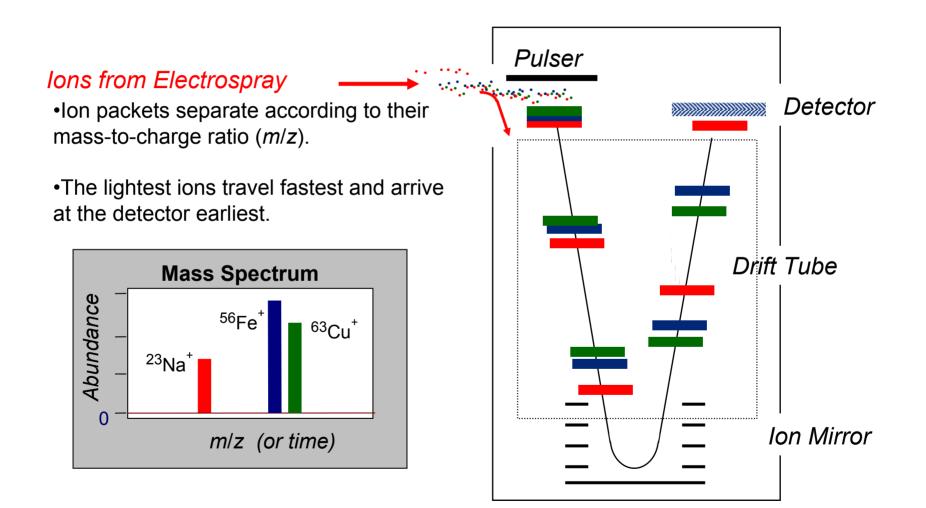


## Electrospray Ionization Interface

from Sample Preparation Unit



## **Time-of-Flight Mass Analyzer**



## IPMS (ES-TOF) Vs. ICP-MS

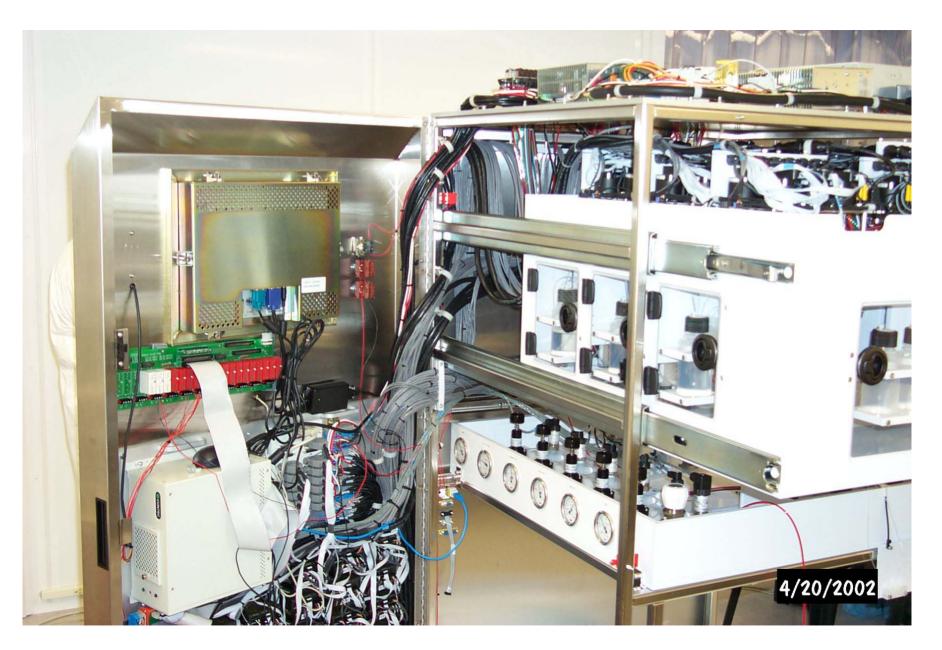
ltem	LMS-300 TCA	ICP-MS
Target Application	Real-time, In-line Trace contamination monitoring of standard aqueous semiconductor solutions	Lab applications
Sample Matrix	UPW, SC1, SC2, IPA, DHF, HN0 <sub>3</sub> , H <sub>2</sub> O <sub>2</sub>	UPW, SC1, SC2, IPA, DHF, HN0 <sub>3</sub> , H <sub>2</sub> O <sub>2</sub>
Monitors	16 (22) Trace Contaminants	Depends Upon Available Standards
	Cations (+) and anions (-)	Cations (+)
	Elements and species	Elements
	Inorganics and Organics	Inorganics
Sample Preparation	Automatic	Manual
Limit of Detection	< 20 ppt	< 20 ppt
Calibration and Quantitation		
Standards	Enriched isotope elemental standard (250 ppb)	Calibration Curves
	NIST natural isotope standard (10 ppm)	
Sample Volume	2 mL	5 mL
Technology	In-Process Mass Spectrometry (IPMS)	ICP-MS
Throughput	8 sample/hr (7.5 min/sample)	24 to 72 hours
Accuracy	± 25% at the quantitation limit	± 25% at the quantitation limit

#### **Trace Contamination Analyzer (TCA) Semiconductor Solution Metrology**

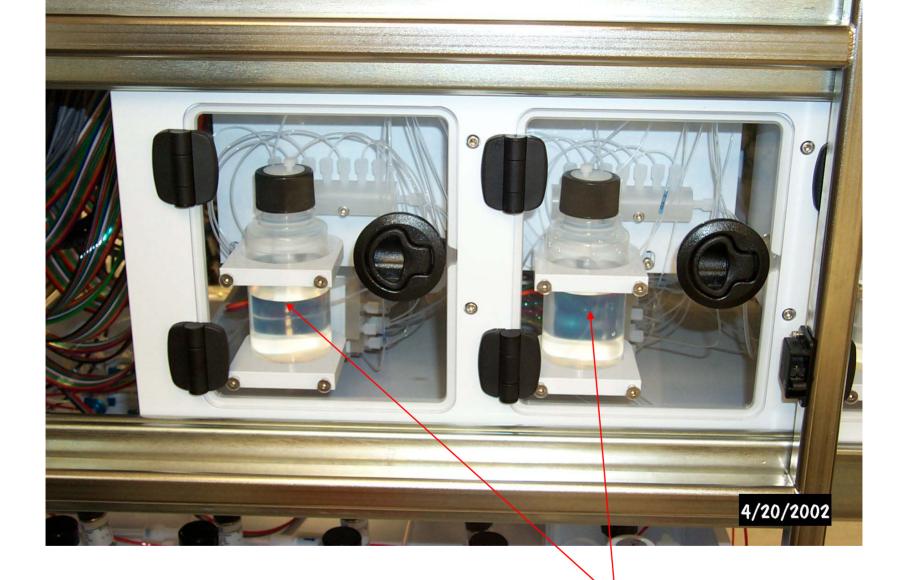




ULSI Conference 3/27/2003







#### "Enriched" Isotope Solutions Standards"



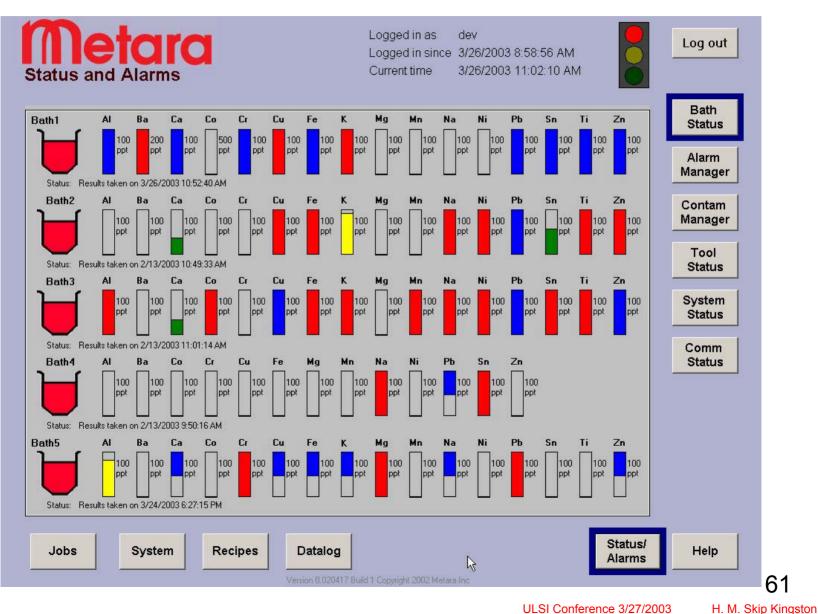
B

ULSI Conference 3/27/2003

## One semiconductor instrument being tested and one being assembled in clean room



#### Decision Information in Graphical User Interface (Beta) (Element selection individualized for a specific Fab)



#### Acknowledgements

#### **Current and Former Research Group Member**

#### **Duquesne University**

Dr. Ye Han **Ds. Helen Boylan** Ms. Sejal lyer Mr. Mizanur Rahman Dr. Dan Taylor Ms. Yusheng Lu **Dr. Dirk Link** Dr. Dengwei Huo **Dr. Stuart Chalk Dr. Peter Walter Dr. Robert Richter** 

Many others

#### Metara Inc.

Dr. Ye Han Dr. Michael West **Dr. Marc Anderson Mr. Larry Stewart** Dr. June Wang **Dr. Jason Wang** Dr. Harmish Seni Mr. Bob Ormond Dr. Kenneth Bhang Mr. Rudy Mui

**Mr. Patrick Franklin** 

manyuothers27/2003 H. M. Skip Kingston

## Acknowledgments

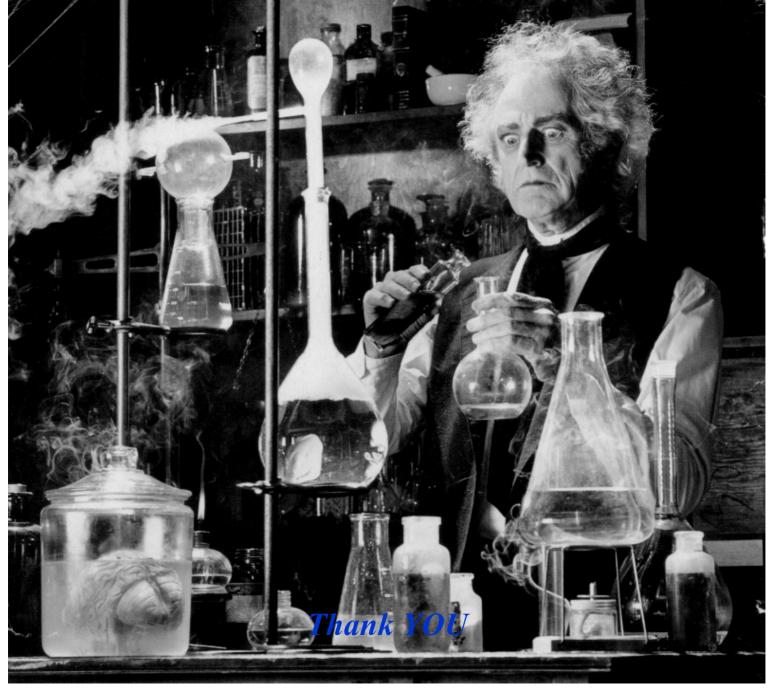
Sponsors and Funding Metara Inc. SAIC & EPA Environmental Standards Allegheny Energy Supply Company Duquesne University

#### **Instrumentation Support** Metara Inc.

Milestone Inc. Agilent Technologies Fisons

Note:

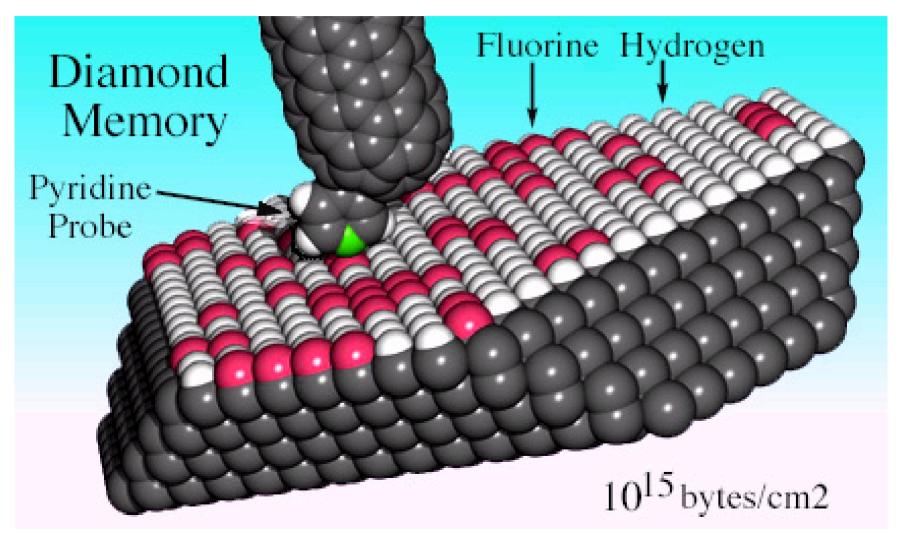
Patents exist and are pending on portions of this research Nationally and Internationally



64 This is not your fathers kind of chemistry on are surface of the M. Skip Kingston



Micromachines of the future will be on an unprecedented scale with atomic and molecular domains where constituent and contaminant analysis must be on these same scales





B

ULSI Conference 3/27/2003